

**PATENT APPLICATION**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of

Docket No: Q88465

Makoto UEKI, et al.

Appln. No.: 10/538,306

Group Art Unit: 2811

Confirmation No.: 3461

Examiner: Ajay ARORA

Filed: June 9, 2005

For: COPPER ALLOY FOR WIRING, SEMICONDUCTOR DEVICE, METHOD FOR  
FORMING WIRING AND METHOD FOR MANUFACTURING SEMICONDUCTOR  
DEVICE

**AMENDMENT UNDER 37 C.F.R. § 1.111**

**MAIL STOP AMENDMENT**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated January 3, 2008, please amend the above-identified application as follows on the accompanying pages.

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